

Title (en)

Target value processing unit, temperature controller, control process implementing system, process controlling method, target value processing program, and recording medium

Title (de)

Zielwert-Behandlungseinheit, Temperaturregler, Steuerungsprozess-Durchführungssystem, Prozesssteuerungsverfahren, Zielwertbehandlungsprogramm und Aufzeichnungsmedium

Title (fr)

Unité de traitement d'une valeur de consigne, régulateur de température, système de mise en oeuvre d'un processus de commande, procédé de commande d'un processus, programme de traitement d'une valeur de consigne et moyen d'enregistrement

Publication

EP 1569054 A3 20060524 (EN)

Application

EP 05003909 A 20050223

Priority

- JP 2004048172 A 20040224
- JP 2005018005 A 20050126

Abstract (en)

[origin: EP1569054A2] A target value processing unit, includes: an input section to which a target value signal showing a target value of a control process is inputted (2); a target value shaping unit (6) shaping the target value signal inputted to the input section, into a signal form which is proper for a control treatment of a regulator (3) implementing the control process; and an output section (1b) outputting to the regulator a shaped target value signal which is shaped by the target value shaping unit. The target value processing unit realizes the high-level control process without improving the regulator.

IPC 8 full level

G05B 11/42 (2006.01); **G05D 23/19** (2006.01); **G05B 5/01** (2006.01); **G05B 11/32** (2006.01); **G05B 13/02** (2006.01); **G05B 19/04** (2006.01); **G05D 23/00** (2006.01); **G08C 13/00** (2006.01)

CPC (source: EP US)

G05B 5/01 (2013.01 - EP US); **G05B 11/32** (2013.01 - EP US); **G05B 11/42** (2013.01 - EP US)

Citation (search report)

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DOCDB simple family (publication)

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DOCDB simple family (application)

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